Ø 001

SEP 1 0 2003

OFFICIAL

Serial No. 09/879,724 Attorney Docket No. F0522 Firm Reference No. AMDSP0414US Reply to Office Action Dated August 19, 2003 Reply Dated September 9, 2003

## CERTIFICATE OF MAILING OR FACSIMILE TRANSMISSION UNDER 37 CFR 1.8(a)

the Commissioner for Patents address below.

X being transmitted via facsimile to (703) 872-9319 at the U.S. Patent and Trademark Office to the Attention of Examiner

Ahmed N. Sefer

Linda McElroy

Scptember 9, 2003

Date

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of:

Applicant: Do

Dong-Hyuk Ju et al.

Art Unit

2826

Serial No:

09/879,724

Examiner

Ahmed N. Sefer

Filing Date:

June 12, 2001

Confirmation No:

4898

Title: LEAKY, THERMALLY CONDUCTIVE INSULATOR MATERIAL (LTCIM) IN SEMICONDUCTOR-ON-INSULATOR (SOI) STRUCTURE

Mail Stop AF: Expedited Procedure

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Mail Stop AF EXPEDITED PROCEDURE

## **REPLY TO OFFICE ACTION DATED AUGUST 19, 2003**

Dear Sir:

Favorable reconsideration of the above-identified application is respectfully requested in view of the following amendments and comments. It is believed that the amendments contained herein raise no new issues, do not require an additional search and place the application in a better condition for allowance and/or appeal. Accordingly, entry of the amendment is considered proper.

Page 1 of 11

Serial No. 09/879,724 Attorney Docket No. F0522 Firm Reference No. AMDSP0414US Reply to Office Action Dated August 19, 2003 Reply Dated September 9, 2003

Amendments in the Claims are reflected in the listing of claims that begins on page 3 of this paper.

Remarks begin on page 8 of this paper.